# **NSR0140P2T5G**

# **Schottky Barrier Diode**

These Schottky barrier diodes are designed for high-speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand-held and portable applications where space is limited.

#### **Features**

- Extremely Fast Switching Speed
- Extremely Low Forward Voltage 0.28 V (Typ) @ I<sub>F</sub> = 1.0 mA
- Low Reverse Current
- Lead-Free Plating
- This is a Pb-Free Device

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak Reverse Voltage	V <sub>RM</sub>	40	V	
Reverse Voltage	V <sub>R</sub>	30	V	
Forward Continuous Current (DC)	I <sub>F</sub>	70	mA	
Peak Forward Surge Current	I <sub>FSM</sub>	500	mA	
ESD Rating: Class 1C per Human Body Model Class A per Machine Model				

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	100	mW mW/°C
Derate above 25 C		1.0	IIIVV/ C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	1000	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +125	°C

1. FR-5 Minimum Pad.



## ON Semiconductor®

http://onsemi.com

## 40 V SCHOTTKY BARRIER DIODE





**PLASTIC** 





M = Specific Device Code

M = Month Code

= Pb-Free Package

(Note: Microdot may be in either location)

## **ORDERING INFORMATION**

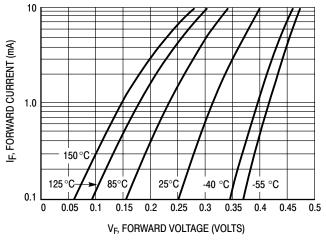
Device	Package	Shipping†
NSR0140P2T5G	SOD-923	2 mm Pitch 8000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **NSR0140P2T5G**

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage $(I_R = 10 \mu A)$	V <sub>(BR)R</sub>	30	-	-	V
Total Capacitance (V <sub>R</sub> = 1.0 V, f = 1.0 MHz)	СТ	-	2.0	2.5	pF
Reverse Leakage (V <sub>R</sub> = 30 V)	I <sub>R</sub>	-	300	500	nA
Forward Voltage (I <sub>F</sub> = 1.0 mA)	V <sub>F</sub>	-	0.28	0.35	V



1000  $T_A = 150^{\circ}C$ I<sub>R</sub>, REVERSE CURRENT (μA) 100 125°C 10 85°C 1.0 0.1 25°C 0.01 0.001 15 20 25 35 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS)

Figure 1. Typical Forward Voltage

Figure 2. Reverse Current versus Reverse Voltage

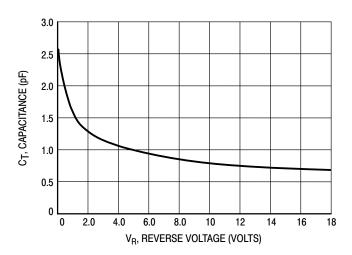
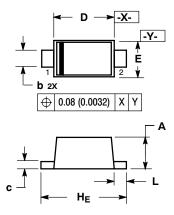


Figure 3. Typical Capacitance

#### NSR0140P2T5G

#### PACKAGE DIMENSIONS

SOD-923 CASE 514AA-01 ISSUE D



#### NOTES:

- NOTES:

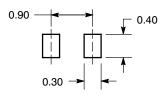
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETERS.

  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.34	0.39	0.43	0.013	0.015	0.017
b	0.15	0.20	0.25	0.006	0.008	0.010
С	0.07	0.12	0.17	0.003	0.005	0.007
D	0.75	0.80	0.85	0.030	0.031	0.033
E	0.55	0.60	0.65	0.022	0.024	0.026
HE	0.95	1.00	1.05	0.037	0.039	0.041
L	0.05	0.10	0.15	0.002	0.004	0.006

#### **SOLDERING FOOTPRINT\***



**DIMENSIONS: MILLIMETERS** 

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<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.